

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT3997848

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JUNG HYE CHAE	08/08/2016
RECEIVING PARTY DATA	
Name:	SEOUL VIOSYS CO., LTD.
Street Address:	65-15, SANDAN-RO 163 BEON-GIL, DANWON-GU
Internal Address:	GYEONGGI-DO
City:	ANSAN-SI
State/Country:	KOREA, REPUBLIC OF
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14355521
CORRESPONDENCE DATA	
Fax Number:	(703)288-5139
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	703-288-5105
Email:	patent@park-law.com
Correspondent Name:	H.C. PARK & ASSOCIATES, PLC
Address Line 1:	1894 PRESTON WHITE DRIVE
Address Line 4:	RESTON, VIRGINIA 20191
ATTORNEY DOCKET NUMBER:	P5911US00
NAME OF SUBMITTER:	HAE-CHAN PARK
SIGNATURE:	/hae-chan park/
DATE SIGNED:	08/08/2016
Total Attachments: 4	
source=P5911US00-ExecutedAssignment-JungHyeCHAE#page1.tif	
source=P5911US00-ExecutedAssignment-JungHyeCHAE#page2.tif	
source=P5911US00-ExecutedAssignment-JungHyeCHAE#page3.tif	
source=P5911US00-ExecutedAssignment-JungHyeCHAE#page4.tif	



Declaration to Execute Assignment Documents for Unavailable Inventor

I submit this declaration based upon personal knowledge of the facts herein.

In accordance with the employee invention compensation regulation based on Articles 2, 10 and 12 of the Invention Promotion Act of Republic of Korea and contractual agreement(s) with Seoul Viosys Co., Ltd. ("Assignee"), the following inventor/ assignor was an employee of Assignee and is obligated under Korea law to assign all rights in and to the following patent application to Assignee.

Title of Invention: LIGHT-EMITTING DIODE PACKAGE AND METHOD FOR MANUFACTURING SAME

U.S. Application No. 14/355,521, filed on April 30, 2014, which is the national stage entry of PCT/KR2012/008153, filed on October 9, 2012, and which claims priority from Korean Patent Application No. 10-2011-0112025, filed on October 31, 2011.

First Assignor

Name: Jung Hye CHAE
Address: 65-16, Sandan-ro 163 beon-gil,
Danwon-gu, Ansan-si,
Gyeonggi-do
Republic of Korea

Moreover, I diligently attempted to contact the above-identified inventor/assignor at his last known address, but have not been successful. Accordingly, and pursuant to Korean law, I am authorized to sign the attached Assignment on behalf of this inventor/assignor.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. § 1001 by fine or imprisonment of not more than five (5) years, or both.



HCPA Park & Associates, PLLC
COUNSELORS AT LAW

Executed on behalf of Seoul Viosys Co., Ltd. at Ansan-si, Gyeonggi-do, Republic of Korea on the date indicated below.

By: Won Cheol Seo
Signature Woncheol Seo
Name Woncheol Seo
Title Patent team manager
Date Aug. 8. 2016.



ASSIGNMENT

Whereas, Assignor has invented certain new and useful processes, machines, articles of manufacture, compositions of matter, and/or improvements thereof ("Invention") disclosed in

☒ an application for United States Letters Patent entitled **LIGHT-EMITTING DIODE PACKAGE AND METHOD FOR MANUFACTURING SAME** ("Application"), said application having been filed on April 30, 2014, and accorded U.S. Appl. No. 14/355,521;

☐ upon which United States Letters Patent, Patent Number _____, has issued ("Patent");

Whereas, Assignor desires to convey all rights, titles, and interests in and to the same to:

**Seoul Viosys Co., Ltd.
65-15, Sandan-ro 163 beon-gil
Danwon-gu, Ansan-si
Gyeonggi-do
Republic of Korea**

Seoul Viosys Co., Ltd. herein further referred to as ("Assignee").

Now, for valuable consideration by Assignee to Assignor, the receipt of which is hereby acknowledged, and for other good and valuable consideration, Assignee and Assignor hereby agree as follows:

Assignor hereby conveys, assigns, sells and transfers to Assignee all rights, title and interests in and to the Invention disclosed in said application and in and to any Letters Patent of the United States (US), any continuation, division, renewal, or substitute thereof, and hereby grant to Assignee the right to apply in its own name for patents or Inventor's certificates and related rights heretofore or hereafter filed for the Invention in any and all countries, including (without limitation) all rights to claim priority based thereon, all patents granted thereon and all reissues, extensions and renewals thereof.

Assignor hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment.

Assignor further covenants that Assignee will, upon Assignee's request, be provided promptly with all pertinent facts and documents relating to the Invention, Patent, Application and any patents granted thereon, as may be known and accessible to Assignor, and Assignor will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to Assignee or Assignee's legal representative any and all papers, instruments or affidavits required to apply for, protect, obtain, maintain, issue, defend and enforce the Application, Patent, Invention, whether in the US or any and all foreign countries



HC Park & Associates, PLC

COUNSELORS at LAW

Attorney's Docket No.: P5911US00

and any patents granted thereon and/or for obtaining any reissue or reissues of any patent which may be granted for the invention and perform such further acts which may be necessary or desirable to carry out the intent of this agreement as the Assignee thereof shall hereafter require and prepare at assignee's expense.

IN WITNESS WHEREOF, Assignor has hereunto set hand and seal.

First Inventor's Name: Jung Hye CHAE

Address: 65-15, Sandan-ro 163 beon-gil
Danwon-gu, Ansan-si
Gyeonggi-do
Republic of Korea

First Inventor's Signature:

Jung Hye Chae / by Woncheol Seo

Date:

August 8, 2016 13 PM KST